

Title (en)
SEMICONDUCTOR COMPONENT HAVING A MICROMECHANICAL MICROPHONE STRUCTURE

Title (de)
HALBLEITERBAUELEMENT MIT EINER MIKROMECHANISCHEN MIKROFONSTRUKTUR

Title (fr)
COMPOSANT À SEMICONDUCTEUR À STRUCTURE DE MICROPHONE MICROMÉCANIQUE

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Application
EP 10715167 A 20100406

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Abstract (en)
[origin: WO2010139496A2] The invention relates to a simple and cost-effective embodiment for a semiconductor component having a micromechanical microphone structure, comprising an acoustically active membrane (21) designed as a deflectable electrode of a microphone condenser, a stationary acoustically permeable counter-element (22) designed as the counter-electrode of the microphone condenser, and means for applying a charge voltage between the deflectable electrode (21) and the counter-electrode (22) of the microphone condenser. In order for the function of said semiconductor component not to be impaired, even during overload situations, in which a contact occurs between the membrane and counter-electrode, the deflectable electrode (21) and the counter-electrode (22) of the microphone condenser are at least regionally counter-doped such that, in case of contact, they form a diode. Furthermore, the charge voltage between the deflectable electrode (21) and the counter-electrode (22) is poled such that said diode is switched in the blocking direction.

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